# F Fuji Electric FMY36N60ES

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**Automotive** 

**FUJI POWER MOSFET** 

## Super FAP-E<sup>3S</sup> Low Qg series N-Channel enhancement mode power MOSFET

#### Features

Low on-state resistance Low switching loss easy to use (more controllable switching dV/dt by Rg) The reliability trial conforms to AEC Q101. 100% avalanche tested





Equivalent circuit schematic

Applications

Automotive switching applications

#### ■ Absolute Maximum Ratings at Tc=25°C(unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	V <sub>DS</sub>	600	v	
	V <sub>DSX</sub>	600	v	V <sub>GS</sub> =-30V
Continuous Drain Current	I <sub>D</sub>	±36	Α	
Pulsed Drain Current	I <sub>DP</sub>	±144	Α	
Gate-Source Voltage	V <sub>GS</sub>	±30	V	
Non-Repetitive Maximum Avalanche current	I <sub>AS</sub>	36	Α	Note*1
Non-Repetitive Maximum Avalanche Energy	E <sub>AS</sub>	830	mJ	Note*2
Peak Diode Recovery dV/dt	dV/dt	4.7	kV/μs	Note*3
Peak Diode Recovery di/dt	-di/dt	100	A/µs	Note*4
Maximum Power Dissipation	PD	570	w	
Operating and Storage Temperature range	T <sub>ch</sub>	150	°C	
	T <sub>stg</sub>	-55 to +150	σ°	

Note\*1 : Tch≦150℃,See Fig.1 and Fig.2

Note\*2 : Starting Tch=25°C,L=1169µH,V<sub>cc</sub>=60V,RG=50Ω,See Fig.1 and Fig.2

E<sub>AS</sub> limited by maximum channel temperature and avalanche current.

See to Avalanche Energy graph of page 5

Note\*3 : IF≦-ID,-di/dt=100A/µs,V<sub>CC</sub>≦BV<sub>DSS</sub>, Tch≦150°C Note\*4 : IF≦-ID,dV/dt=4.7kV/µs,V<sub>CC</sub>≦BV<sub>DSS</sub>, Tch≦150°C

Electrical Characteristics at Tc=25°C(unless otherwise specified) Static Ratings

Description	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =1mA V <sub>GS</sub> =0V		600	-		v
	BV <sub>DSX</sub>	I <sub>D</sub> =1mA V <sub>GS</sub> =-30V		600	1	1	v
Gate Threshold Voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =250μA V <sub>DS</sub> = V <sub>GS</sub>		3.7	4.2	4.7	v
Zero Gate Voltage Drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 600V V <sub>GS</sub> =0V	Ta=25℃	-	0.7	10	-μA
		V <sub>DS</sub> = 480V V <sub>GS</sub> =0V	Ta=125℃	-	25	250	
Gate-Source Leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =30V V <sub>DS</sub> = 0V		_	10	100	nA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =18A V <sub>GS</sub> =10V		_	137	160	mΩ

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#### **Dynamic Ratings**

Description	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	9 <sub>fs</sub>	I <sub>D</sub> =18A V <sub>DS</sub> =25V	15	_	Ι	S
Input Capacitance	C <sub>iSS</sub>	V <sub>DS</sub> =25V	—	6000	_	pF
Output Capacitance	C <sub>oSS</sub>	V <sub>GS</sub> =0V	—	650	_	
Reverse Transfer Capacitance	C <sub>rSS</sub>	f=1MHz	—	30	-	
Turn-On Time	t <sub>d(on)</sub>		—	58	-	ns
Turn-On Time	t,	V <sub>cc</sub> =300V, V <sub>gs</sub> =10V	—	75	-	
Turn-Off Time	t <sub>d(off)</sub>	$I_D$ =18A, R <sub>G</sub> =10Ω See Fig.3 and Fig.4	_	115	-	
Turn-Off Time	t <sub>f</sub>		—	30	_	
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> =300V, I <sub>D</sub> =36A	-	148	-	nC
Gate-Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> =10V	—	50	-	
Gate-Drain Charge	Q <sub>GD</sub>	See Fig.5	_	60	-	
Reverse Ratings						
Description	Symbol	Conditions	Min.	Тур.	Max.	Unit
Avalanche Capability	I <sub>AV</sub>	L=1169µН, T <sub>ch</sub> =25°С See Fig.1 and Fig.2	36	-	-	Α
Diode Forward On- Voltage	V <sub>SD</sub>	I <sub>F</sub> =36A, V <sub>GS</sub> =0V T <sub>ch</sub> =25℃	_	1.10	1.5	v
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =36A, V <sub>GS</sub> =0V -di/dt=100A/µs	_	920	_	ns
Reverse Recovery Charge	Q <sub>rr</sub>	-α//αt=100A/μs T <sub>ch</sub> =25℃	_	22	-	μC

#### ■Thermal Characteristics

Description	Symbol	Min.	Тур.	Max.	Unit
Cannel to Case	R <sub>th(ch-c)</sub>	1	—	0.219	°C/W
Cannel to Ambient	R <sub>th(ch-a)</sub>	1	—	50.0	°C/W

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Typical Drain-Source on-State Resistance RDS(on)=f (ID):80µ s pulse test, Tch=25°C



IF [A]

1

0.1

0.0 0.2 0.4 0.6 0.8

1.0 1.2

VSD [V]

1.4 1.6

1.8 2.0

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Fig.1 Avalanche Test circuit

Fig.2 Operating waveforms of Avalanche Test





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Fig.3 Switching Test circuit



Fig.4 Operating waveform of Switching Test



Fig.5 Operating waveform of Gate charge Test

Fig.6 Operating waveform of Body diode Recovery Test





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Out view

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